- Operating Range: 2-V to 5.5-V V<sub>CC</sub>
- EPIC<sup>™</sup> (Enhanced-Performance Implanted CMOS) Process
- High Latch-Up Immunity Exceeds 250 mA Per JEDEC Standard JESD-17
- Packaged in Plastic Small-Outline Transistor Package

# DBV PACKAGE (TOP VIEW) A 1 5 V<sub>CC</sub> B 2 GND 3 4 Y

## description

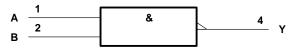
The SN74AHC1G00 performs the Boolean function  $Y = \overline{A \bullet B}$  or  $Y = \overline{A} + \overline{B}$  in positive logic.

The SN74AHC1G00 is characterized for operation from -40°C to 85°C.

### **FUNCTION TABLE**

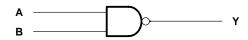
INP	UTS	OUTPUT
Α	В	Υ
Н	Н	L
L	X	Н
Х	L	Н

## logic symbol†



† This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

## logic diagram (positive logic)





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## absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage range, V <sub>CC</sub>	$\dots$ $-0.5$ V to 7 V
Input voltage range, V <sub>I</sub> (see Note 1)	$\dots$ –0.5 V to 7 V
Output voltage range, V <sub>O</sub> (see Note 1)	0.5 V to $V_{CC} + 0.5$
Input clamp current, $I_{ K }(V_{ } < 0)$	– 20 mA
Output clamp current, $I_{OK}$ ( $V_O < 0$ or $V_O > V_{CC}$ )	$\dots\dots\pm 20~mA$
Continuous output current, $I_O$ ( $V_O = 0$ to $V_{CC}$ )	$\dots\dots\pm 25~\text{mA}$
Continuous current through V <sub>CC</sub> or GND	$\dots\dots\pm 50~\text{mA}$
Maximum power dissipation at $T_A = 55^{\circ}C$ (in still air)(see Note 2)	
Storage temperature range, T <sub>stg</sub>	-65°C to 150°C

<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

## recommended operating conditions (see Note 3)

			MIN	MAX	UNIT
Vcc	Supply voltage		2	5.5	V
		V <sub>CC</sub> = 2 V	1.5		
$V_{IH}$	High-level input voltage V <sub>CC</sub> = 3 V	2.1		V	
		V <sub>CC</sub> = 5.5 V	3.85		
		$V_{CC} = 2 V$		0.5	
$V_{IL}$	Low-level input voltage V <sub>CC</sub> = 3 V		0.9	V	
		V <sub>CC</sub> = 5.5 V		1.65	
٧ <sub>I</sub>	Input voltage		0	5.5	V
٧o	Output voltage		0	VCC	V
		V <sub>CC</sub> = 2 V		-50	μΑ
IOH	High-level output current	$V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$		-4	mA
		$V_{CC} = 5 V \pm 0.5 V$		-8	ША
		V <sub>CC</sub> = 2 V		50	μΑ
loL	Low-level output current $V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$			4	A
		$V_{CC} = 5 V \pm 0.5 V$		8	mA
A+/A>	Input transition rise or fall rate $ \frac{\text{V}_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}}{\text{V}_{CC} = 5 \text{ V} \pm 0.5 \text{ V}} $			100	ns/V
Δt/Δv				20	115/ V
T <sub>A</sub>	Operating free-air temperature		-40	85	°C

NOTE 3: Unused inputs must be held high or low to prevent them from floating.



NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

<sup>2.</sup> The maximum package power dissipation is calculated using a junction temperature of 150°C and a board trace length of 25 millimeters.

## electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

	ARAMETER	TEST CONDITIONS	V	T <sub>A</sub> = 25°C			MIN	MAX	UNIT	
	ARAWEIER	TEST CONDITIONS	vcc	MIN	TYP	MAX	IVIIIV	WAX	UNIT	
			2 V	1.9	2		1.9			
		I <sub>OH</sub> = -50 μA	3 V	2.9	3		2.9			
∨он			4.5 V	4.4	4.5		4.4		V	
		I <sub>OH</sub> = -4 mA	3 V	2.58			2.48			
		I <sub>OH</sub> = -8 mA	4.5 V	3.94			3.8			
						0.1		0.1		
		I <sub>OL</sub> = 50 μA	3 V			0.1		0.1	V	
VOL	VOL		4.5 V			0.1		0.1		
		I <sub>OL</sub> = 4 mA	3 V			0.36		0.44	1	
		I <sub>OL</sub> = 8 mA	4.5 V			0.36		0.44		
Ιį	A or B inputs	$V_I = V_{CC}$ or GND	5.5 V			±0.1		±1	μΑ	
Icc		$V_I = V_{CC}$ or GND, $I_O = 0$	5.5 V			2		20	μΑ	
Ci		$V_I = V_{CC}$ or GND	5 V		2	10		10	pF	

# switching characteristics over recommended operating free-air temperature range, $V_{CC}$ = 3.3 V $\pm$ 0.3 V (unless otherwise noted) (see Figure 1)

PARAMETER	FROM	TO (OUTPUT)	LOAD CAPACITANCE	T <sub>A</sub> = 25°C			MIN	MAX	UNIT
FARAWIETER	(INPUT)			MIN	TYP	MAX	IVIIIV	WAA	UNIT
<sup>t</sup> PLH	A or B	A or B Y	C <sub>L</sub> = 15 pF		5.5	7.9	1	9.5	ns
t <sub>PHL</sub>					5.5	7.9	1	9.5	115
<sup>t</sup> PLH	A or B	Y	C 50 pF		8	11.4	1	13	no
<sup>t</sup> PHL	AUIB		A UI D	C <sub>L</sub> = 50 pF		8	11.4	1	13

# switching characteristics over recommended operating free-air temperature range, $V_{CC}$ = 5 V $\pm$ 0.5 V (unless otherwise noted) (see Figure 1)

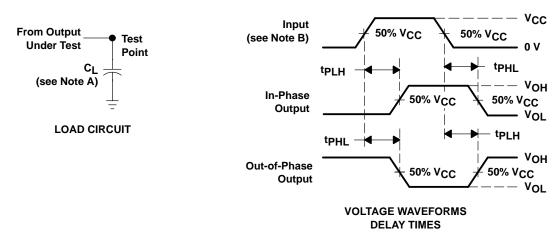
PARAMETER	FROM	TO (OUTPUT)		T <sub>A</sub> = 25°C			MIN	MAX	UNIT		
PARAWETER	(INPUT)			(OUTPUT) CAPACITANCE	CAPACITANCE	MIN	TYP	MAX	IVIIIV	IVIAA	OIVII
tPLH	A or B	V	V	V	V C 15 pE		3.7	5.5	1	6.5	ns
t <sub>PHL</sub>	AOIB	'	$C_L = 15 pF$	OL = 13 pr		3.7	5.5	1	6.5	115	
tPLH	A or B	A or D	Y	C. 50 pF		5.2	7.5	1	8.5	20	
t <sub>PHL</sub>		Y		<b>5</b>   T	C <sub>L</sub> = 50 pF		5.2	7.5	1	8.5	ns

## operating characteristics, $V_{CC} = 5 \text{ V}$ , $T_A = 25^{\circ}\text{C}$

PARAMETER		TEST CO	NDITIONS	TYP	UNIT
C <sub>pd</sub>	Power dissipation capacitance	No load,	f = 1 MHz	9.5	pF



## PARAMETER MEASUREMENT INFORMATION



NOTES: A. C<sub>L</sub> includes probe and jig capacitance.

- B. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  1 MHz,  $Z_O = 50 \Omega$ ,  $t_f = 3 \text{ ns}$ ,  $t_f = 3 \text{ ns}$ .
- C. The output is measured with one input transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms

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